STP12N50M2



N-channel 500 V, 0.325 Ω typ.,10 A MDmesh II Plus™ low Q_g Power MOSFET in a TO-220 package

Datasheet - preliminary data

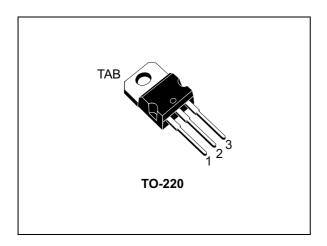
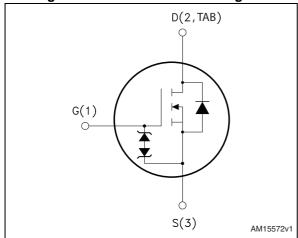


Figure 1. Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	I _D
STP12N50M2	500 V	0.38Ω	10 A

- Extremely low gate charge
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using a new generation of MDmesh $^{\mathsf{TM}}$ technology: MDmesh II Plus $^{\mathsf{TM}}$ low Q_g . This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

Table 1. Device summary

Order code	Marking	Package	Packaging
STP12N50M2	12N50M2	TO-220	Tube

Contents STP12N50M2

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STP12N50M2 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	10	Α
I _D	Drain current (continuous) at T _C = 100 °C	7	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	40	Α
P _{TOT}	Total dissipation at T _C = 25 °C	85	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
T _j	Max. operating junction temperature	- 55 to 150	

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.47	°C/W
R _{thj-amb}	Thermal resistance junction-amb max	62.5	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	3.5	А
E _{AS}	Single pulse avalanche energy (starting T_j =25°C, I_D = I_{AR} ; V_{DD} =50)	204	mJ

^{2.} $I_{SD} \leq$ 10 A, di/dt \leq 400 A/ μ s; $V_{DS\ peak}$ < $V_{(BR)DSS}$, V_{DD} =400 V.

^{3.} $V_{DS} \le 400 \text{ V}$

Electrical characteristics STP12N50M2

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	500			V
	Zero gate voltage	$V_{GS} = 0, V_{DS} = 500 \text{ V}$			1	μΑ
I _{DSS}	drain current	$V_{GS} = 0$, $V_{DS} = 500 V$, $T_C = 125 °C$			100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 25 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 5 A		0.325	0.38	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	560	-	pF
C _{oss}	Output capacitance	$V_{GS} = 0, V_{DS} = 100 V,$	-	33	-	pF
C _{rss}	Reverse transfer capacitance	f = 1 MHz	-	1	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{GS} = 0, V _{DS} = 0 to 400 V	-	125	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz open drain	-	6.8	-	Ω
Qg	Total gate charge		-	15	-	nC
Q _{gs}	Gate-source charge	V _{DD} = 400 V, I _D = 10 A, V _{GS} = 10 V (see <i>Figure 15</i>)	-	3	-	nC
Q_{gd}	Gate-drain charge	1GS 10 1 (000 / 194/0 / 10)	-	8.3	-	nC

^{1.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}



Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	13.5	-	ns
t _r	Rise time	$V_{DD} = 250 \text{ V}, I_D = 5 \text{ A},$	-	10.5	-	ns
t _{d(off)}	Turn-off delay time	$R_G = 4.7 \Omega, V_{GS} = 10 V$ (see <i>Figure 14</i> and <i>19</i>)	-	8	-	ns
t _f	Fall time		-	34.5	-	ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		10	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		40	Α
V _{SD} ⁽²⁾	Forward on voltage	on voltage $V_{GS} = 0$, $I_{SD} = 10$ A			1.6	٧
t _{rr}	Reverse recovery time	10.40.4.45/-14.400.4/	-	276		ns
Q_{rr}	Reverse recovery charge	$I_{SD} = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V (see Figure 16)}$	-	2.4		μC
I _{RRM}	Reverse recovery current	TDD cor (coorigano re)	-	17.5		Α
t _{rr}	Reverse recovery time	I _{SD} = 10 A, di/dt = 100 A/ <i>μ</i> s	-	376		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, T _j =150 °C	-	3.4		μC
I _{RRM}	Reverse recovery current	(see Figure 16)	-	18.3		Α

^{1.} Pulse width limited by safe operating area

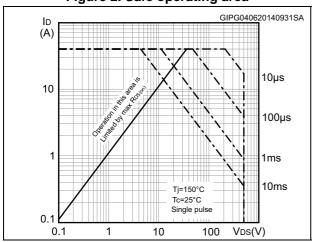
^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STP12N50M2

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance



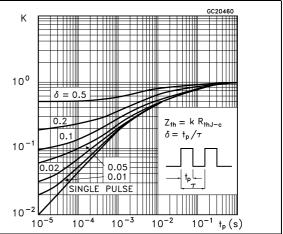
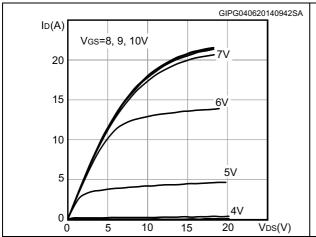


Figure 4. Output characteristics

Figure 5. Transfer characteristics



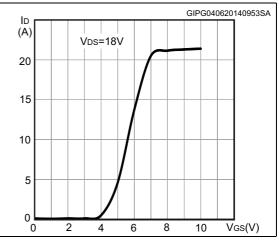
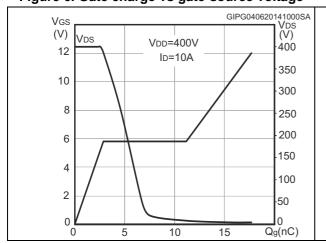


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



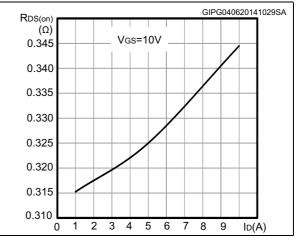


Figure 8. Capacitance variations

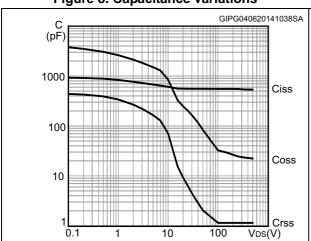


Figure 9. Output capacitance stored energy

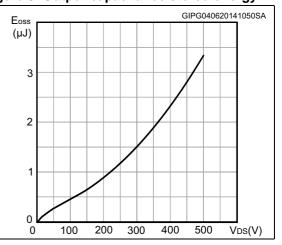


Figure 10. Normalized gate threshold voltage vs temperature

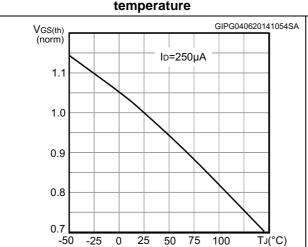


Figure 11. Normalized on-resistance vs temperature

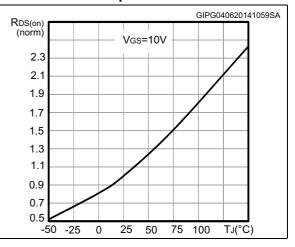


Figure 12. Normalized V_{(BR)DSS} vs temperature

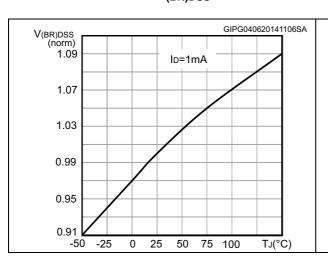
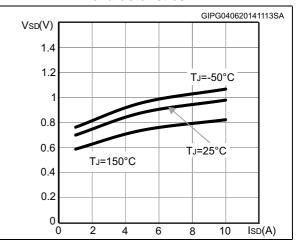


Figure 13. Source-drain diode forward characteristics



Test circuits STP12N50M2

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

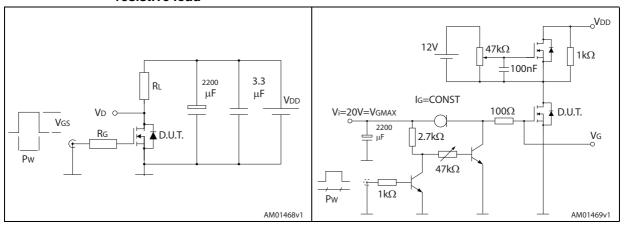


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

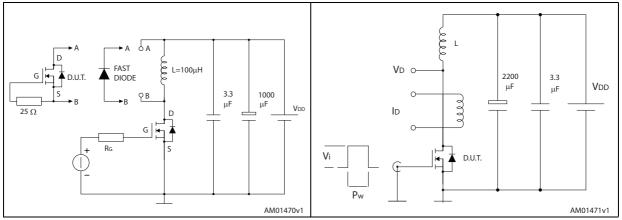
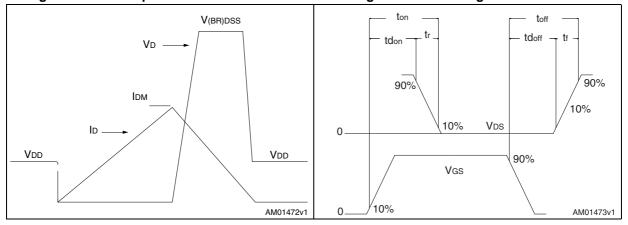


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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4 Package mechanical data

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øΡ Ε H1 D <u>D1</u> L20 L30 b1(X3) -- b (X3) _e1___ 0015988_typeA_Rev_T

Figure 20. TO-220 type A drawing

Table 9. TO-220 type A mechanical data

Dim	100000110	mm	
Dim.	Min.	Тур.	Max.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95



Revision history STP12N50M2

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
17-Jun-2014	1	First release.

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